SN54AHCT05, SN74AHCT05
HEX INVERTERS
WITH OPEN-DRAIN OUTPUTS

SCLS358A – MAY 1997 – REVISED JUNE 1997

- Inputs Are TTL-Voltage Compatible
- *EPIC*™ (Enhanced-Performance Implanted CMOS) Process
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs
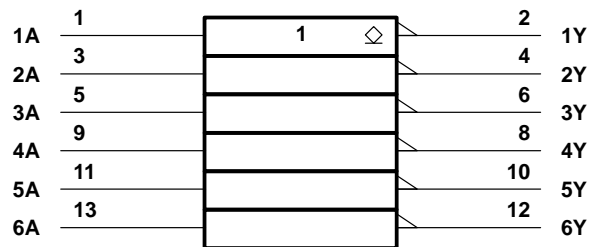
description

The 'AHCT05 contain six independent inverters. These devices perform the Boolean function $Y = \overline{A}$. The open-drain outputs require pullup resistors to perform correctly. They may be connected to other open-drain outputs to implement active-low wired-OR or active-high wired-AND functions.

The SN54AHCT05 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74AHCT05 is characterized for operation from –40°C to 85°C.
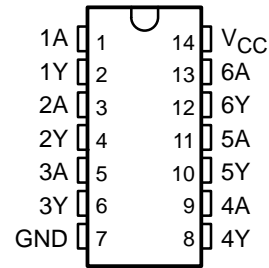
FUNCTION TABLE
(each inverter)

INPUT A	OUTPUT Y
H	L
L	H

SN54AHCT05 . . . J OR W PACKAGE
SN74AHCT05 . . . D, DB, N, OR PW PACKAGE
(TOP VIEW)

1A	1	14	V_{CC}
1Y	2	13	6A
2A	3	12	6Y
2Y	4	11	5A
3A	5	10	5Y
3Y	6	9	4A
GND	7	8	4Y

SN54AHCT05 . . . FK PACKAGE
(TOP VIEW)

NC – No internal connection

logic symbol†

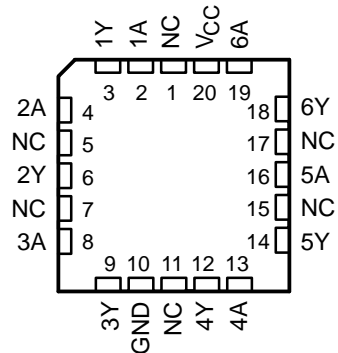| 1A | 1 | 1 | ◇ | 2 | 1Y |
2A	3			4	2Y
3A	5			6	3Y
4A	9			8	4Y
5A	11			10	5Y
6A	13			12	6Y

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, DB, J, N, PW, and W packages.

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logic diagram (positive logic)

A   ————————▷○———————— Y
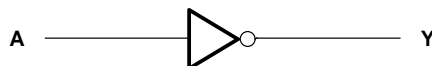
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} .... –0.5 V to 7 V
Input voltage range, V_I (see Note 1) .... –0.5 V to 7 V
Output voltage range, V_O (see Note 1) .... –0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} (V_I < 0) .... –20 mA
Output clamp current, I_{OK} (V_O < 0 or V_O > V_{CC}) .... ±20 mA
Continuous output current, I_O (V_O = 0 to V_{CC}) .... ±25 mA
Continuous current through V_{CC} or GND .... ±50 mA
Package thermal impedance, θ_{JA} (see Note 2): D package .... 127°C/W
                                                    DB package .... 158°C/W
                                                    N package .... 78°C/W
                                                    PW package .... 170°C/W
Storage temperature range, T_{stg} .... –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
        2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions (see Note 3)

		SN54AHCT05		SN74AHCT05		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage	2		2		V
V_{IL}	Low-level input voltage		0.8		0.8	V
V_I	Input voltage	0	5.5	0	5.5	V
V_O	Output voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current		–8		–8	mA
I_{OL}	Low-level output current		8		8	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		20		20	ns/V
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	$T_A = 25°C$			SN54AHCT05		SN74AHCT05		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	$I_{OH} = -50\ \mu A$	4.5 V	4.4	4.5		4.4		4.4		V
	$I_{OH} = -8\ mA$		3.94			3.8		3.8		
V_{OL}	$I_{OL} = 50\ \mu A$	4.5 V			0.1		0.1		0.1	V
	$I_{OL} = 8\ mA$				0.36		0.44		0.44	
I_I	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μA
I_{CC}	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			2		20		20	μA
ΔI_{CC}†	One input at 3.4 V, Other inputs at V_{CC} or GND	5.5 V			1.35		1.5		1.5	mA
C_i	$V_I = V_{CC}$ or GND	5 V		2	10				10	pF

† This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	SN54AHCT05					UNIT
				$T_A = 25°C$			MIN	MAX	
				MIN	TYP	MAX			
t_{PLH}*	A	Y	$C_L = 15\ pF$		3.8	5.5	1	6.5	ns
t_{PHL}*					3.8	5.5	1	6.5	
t_{PLH}	A	Y	$C_L = 50\ pF$		5.3	7.5	1	8.5	ns
t_{PHL}					5.3	7.5	1	8.5	

* On products compliant to MIL-PRF-38535, this parameter is ensured but not production tested.

switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	SN74AHCT05					UNIT
				$T_A = 25°C$			MIN	MAX	
				MIN	TYP	MAX			
t_{PLH}	A	Y	$C_L = 15\ pF$		3.8	5.5	1	6.5	ns
t_{PHL}					3.8	5.5	1	6.5	
t_{PLH}	A	Y	$C_L = 50\ pF$		5.3	7.5	1	8.5	ns
t_{PHL}					5.3	7.5	1	8.5	

noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 4)

PARAMETER		SN74AHCT05			UNIT
		MIN	TYP	MAX	
$V_{OL(P)}$	Quiet output, maximum dynamic V_{OL}		0.4		V
$V_{OL(V)}$	Quiet output, minimum dynamic V_{OL}		−0.4		V
$V_{OH(V)}$	Quiet output, minimum dynamic V_{OH}		4.8		V
$V_{IH(D)}$	High-level dynamic input voltage		2		V
$V_{IL(D)}$	Low-level dynamic input voltage			0.8	V

NOTE 4:   Characteristics are determined during product characterization and ensured by design for surface-mount packages only.

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operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS		TYP	UNIT
C_{pd}	Power dissipation capacitance	No load,	f = 1 MHz	12	pF

PARAMETER MEASUREMENT INFORMATION

LOAD CIRCUIT

**VOLTAGE WAVEFORMS
DELAY TIMES**
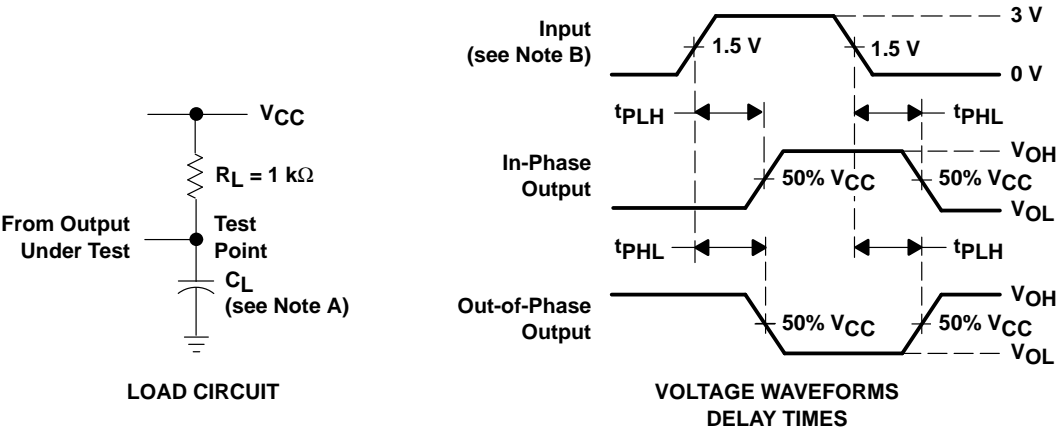
NOTES: A. C_L includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r = 3 ns, t_f = 3 ns.
C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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